AP03048JA

30V P-Channel MOSFET

Features

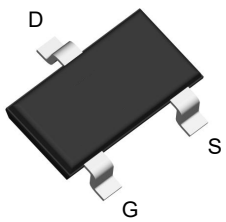
- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summary

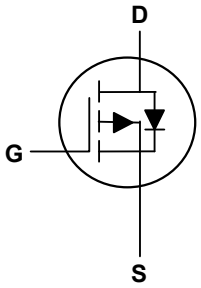
V_{DS}	-30	V
I_D	-4.8	A
$R_{DS(ON)}$ (at V_{GS}=-10V)	50	mΩ
$R_{DS(ON)}$ (at V_{GS}=-4.5V)	65	mΩ

Applications

- High Frequency Point-of-Load,Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch



SOT23 Top View



Absolute Maximum Ratings(T_C=25℃, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	±12	V
Continuous Drain Current[1]	I_D@T_C=25℃	-4.8	A
Continuous Drain Current[1]	I_D@T_C=100℃	-2.8	A
Pulsed Drain Current[2]	I_{DM}	-30	A
Total Power Dissipation[4]	P_D	1.3	W
Storage Temperature Range	T_{STG}	-55 to 150	℃
Operating Junction Temperature Range	T_J	-55 to 150	℃

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient[1]	$R_{\theta JA}$	---	96	℃/W

Electrical Characteristics (T_J=25℃, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V , I_D=-250uA	-30	---	---	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-10V , I_D=-4.2A	---	38	50	mΩ
		V_{GS}=-4.5V , I_D=-4A	---	43	65	mΩ
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS} , I_D =-250uA	-0.5	---	-1.2	V
Drain-Source Leakage Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V	---	---	-1	uA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±12V , V_{DS}=0V	---	---	±100	nA
Total Gate Charge	Q_g	V_{DS}=-15V , V_{GS}=-10V , I_D=-4.5A	---	7.6	---	nC
Gate-Source Charge	Q_{gs}		---	2.2	---	
Gate-Drain Charge	Q_{gd}		---	3.1	---	
Turn-On Delay Time	$T_{d(on)}$	V_{DS}=-15V , V_{GS}=-10V , R_G=6Ω	---	5	---	ns
Rise Time	T_r		---	6	---	
Turn-Off Delay Time	$T_{d(off)}$		---	28	---	
Fall Time	T_f		---	7.6	---	
Input Capacitance	C_{iss}	V_{DS}=-15V , V_{GS}=0V , f=1MHz	---	570	---	pF
Output Capacitance	C_{oss}		---	643	---	
Reverse Transfer Capacitance	C_{rss}		---	563	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage[2]	V_{SD}	V_{GS}=0V , I_S=-4.8A	---	---	-1.2	V

Note:

1.The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%

3.The power dissipation is limited by 150℃ junction temperature

Typical Characteristics

Figure1. Power Dissipation

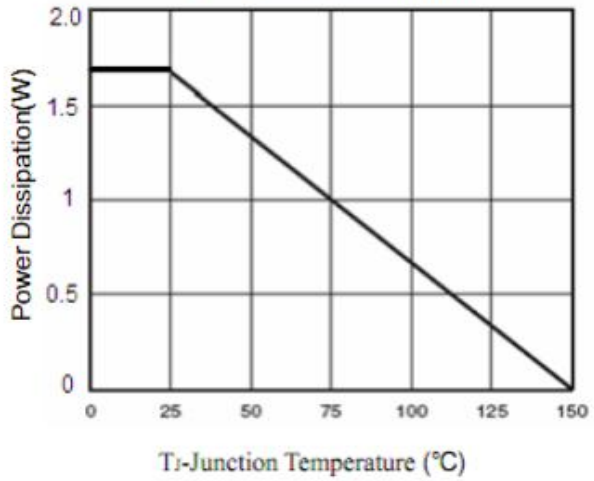


Figure2. Drain Current

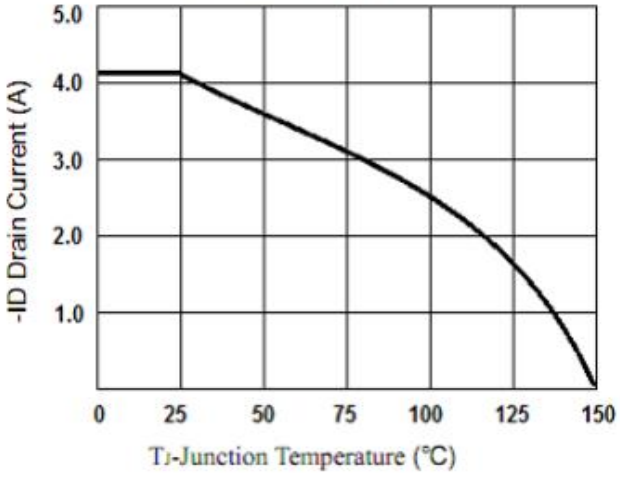


Figure3. Output Characteristics

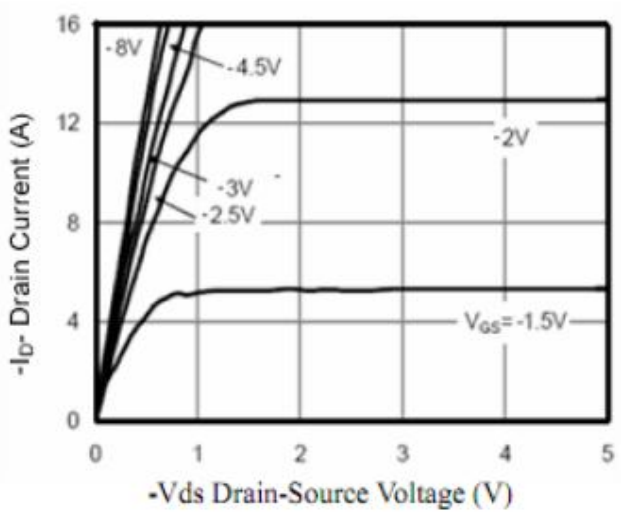


Figure4. Transfer Characteristics

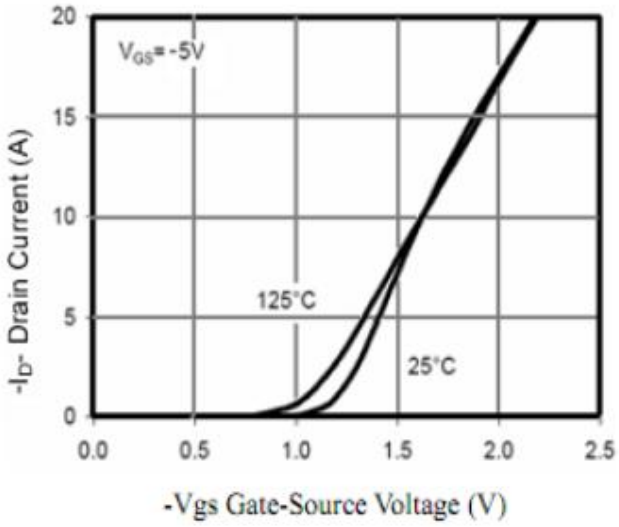


Figure5. Capacitance

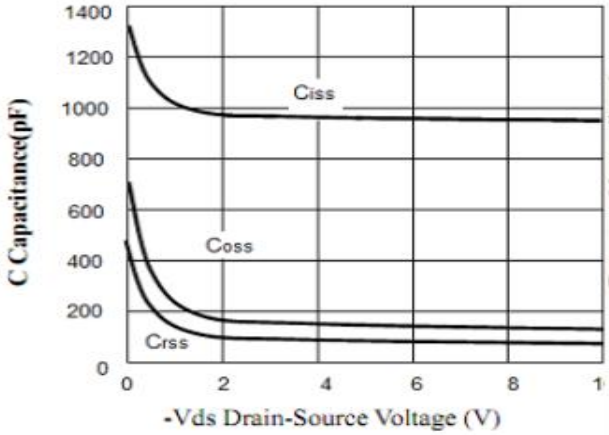


Figure6. $R_{DS(ON)}$ vs Junction Temperature

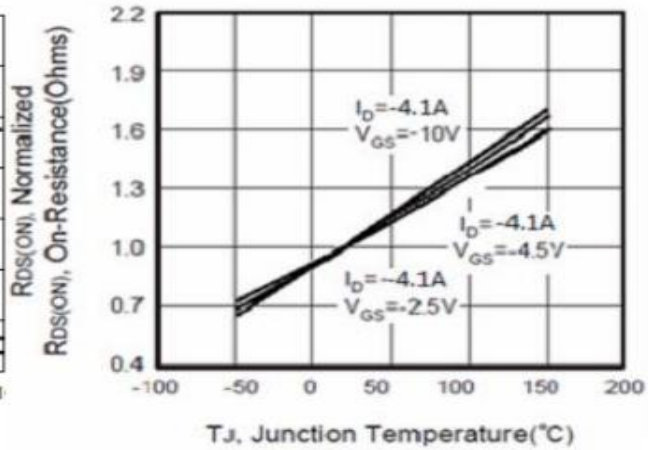


Figure7. Max BV_{DSS} vs Junction Temperat

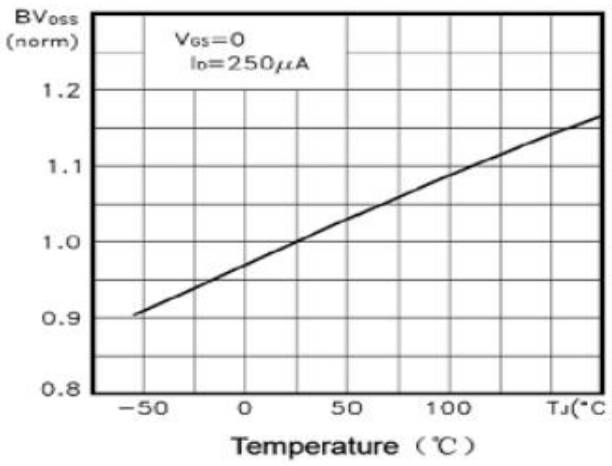


Figure8. $V_{GS(th)}$ vs Junction Temperature

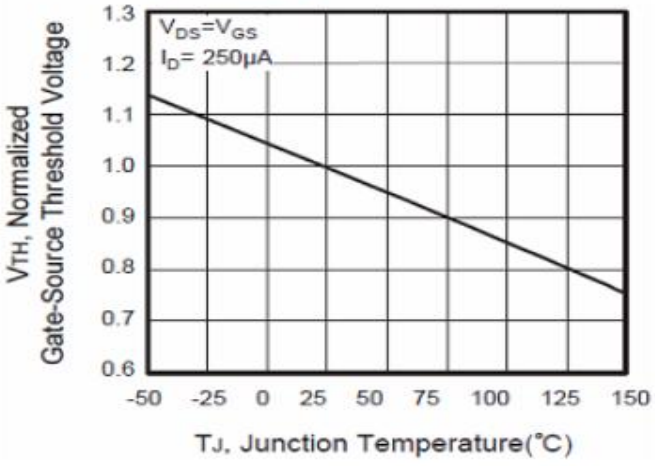


Figure9. Gate Charge Waveforms

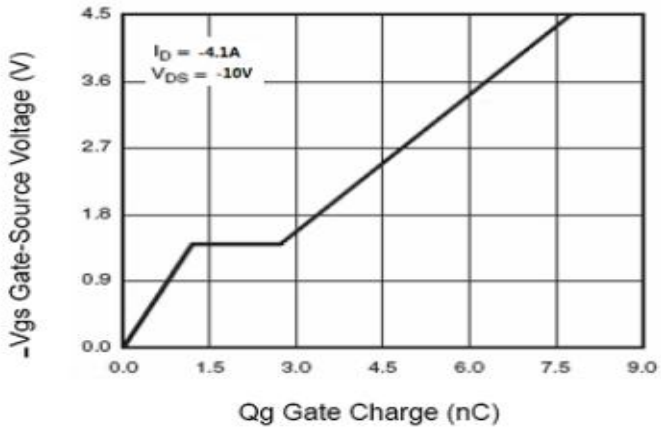


Figure10. Maximum Safe Operating Area

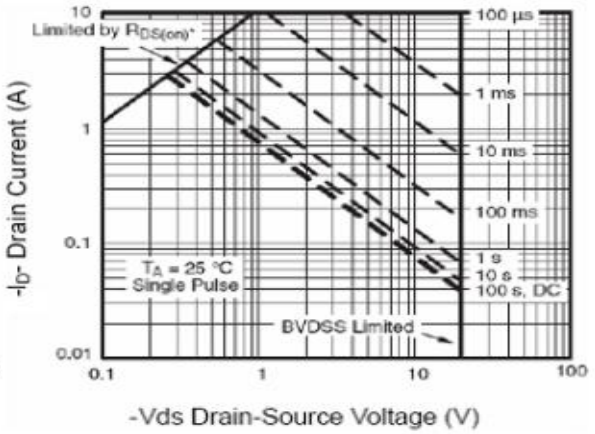
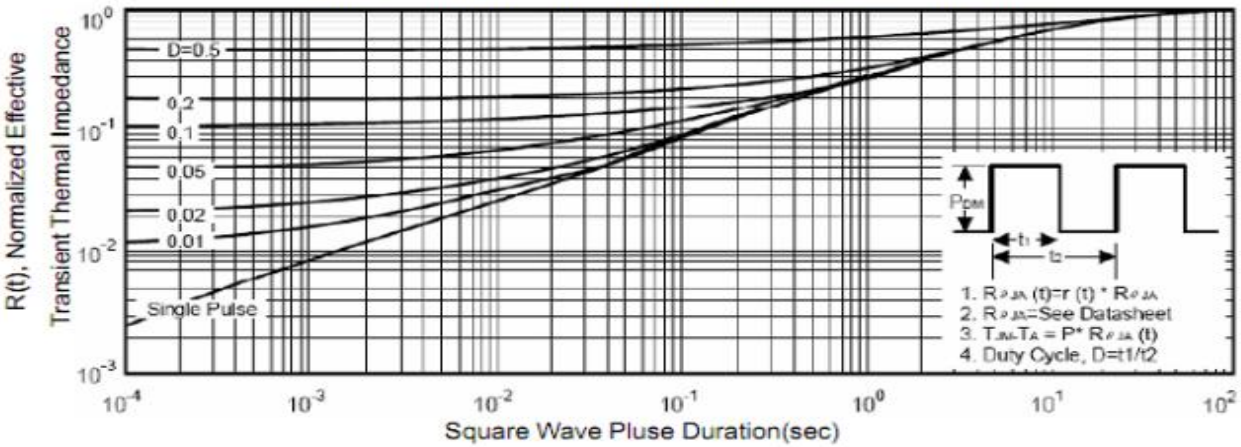
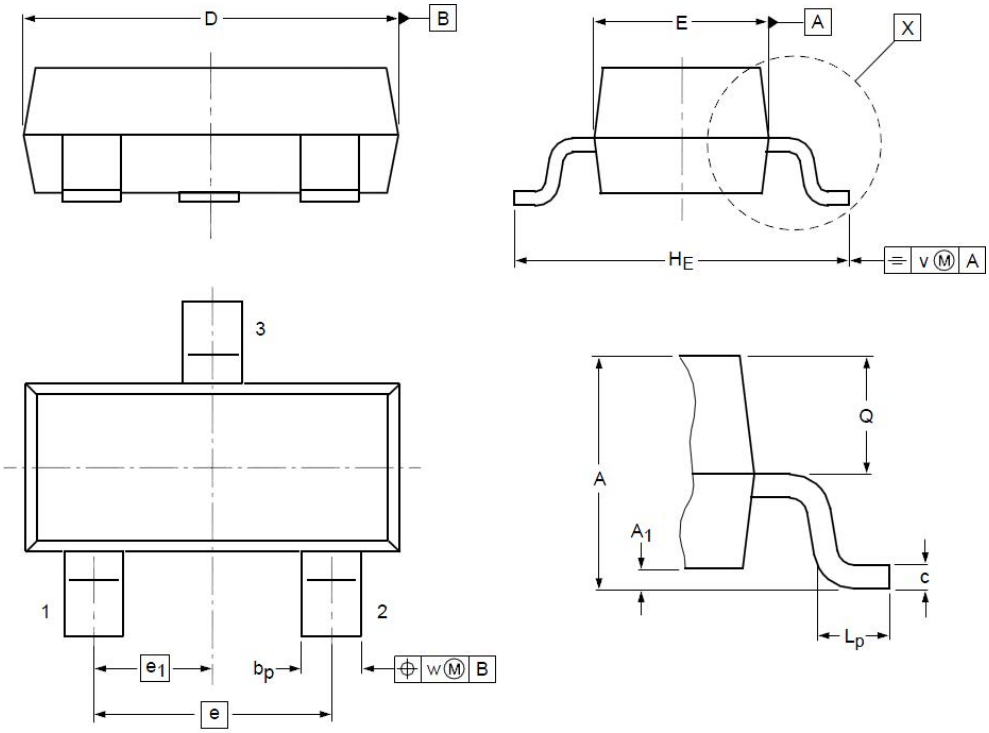


Figure11. Normalized Maximum Transient Thermal Impedance



SOT23 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.90	1.05	1.20	**e_1**	--	0.95	--
A_1	0.01	0.05	0.10	**H_E**	2.10	2.40	2.50
b_p	0.38	0.42	0.48	**L_P**	0.40	0.50	0.60
c	0.09	0.13	0.15	**Q**	0.45	0.49	0.55
D	2.80	2.92	3.00	**V**	--	0.20	--
E	1.20	1.33	1.40	**W**	--	0.10	--
e	--	1.90	--				